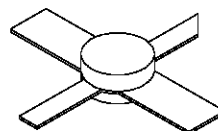


## RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- 1025 - 1150 MHz
- RUGGEDIZED VSWR  $\infty:1$
- INTERNAL INPUT MATCHING
- LOW THERMAL RESISTANCE
- $P_{OUT} = 4.0$  W MIN. WITH 9.0 dB GAIN



**.280 4LFL (SO51)**  
epoxy sealed

**ORDER CODE**  
MSC1004MP

**BRANDING**  
1004MP

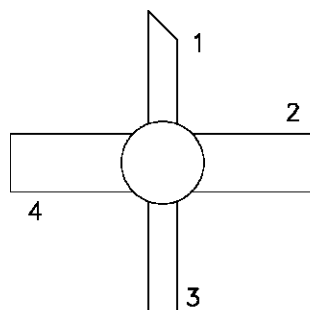
### DESCRIPTION

The MSC1004MP is a low-level Class C pulsed transistor specifically designed for DME/IFF driver or output applications.

These devices are capable of withstanding a  $\infty:1$  load VSWR at any phase angle under full rated conditions. Low RF thermal resistance and automatic bonding techniques ensure high reliability and product consistency.

The MSC1004MP is housed in the IMPAC™ package with internal input matching.

### PIN CONNECTION



- |              |            |
|--------------|------------|
| 1. Collector | 3. Emitter |
| 2. Base      | 4. Base    |

### ABSOLUTE MAXIMUM RATINGS ( $T_{case} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit
$P_{DISS}$	Power Dissipation* ( $T_C \leq 100^{\circ}C$ )	18	W
$I_C$	Device Current*	650	mA
$V_{CC}$	Collector-Supply Voltage*	32	V
$T_J$	Junction Temperature	200	$^{\circ}C$
$T_{STG}$	Storage Temperature	- 65 to +150	$^{\circ}C$

### THERMAL DATA

$R_{TH(j-c)}$	Junction-Case Thermal Resistance*	5	$^{\circ}C/W$
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\*Applies only to rated RF amplifier operation

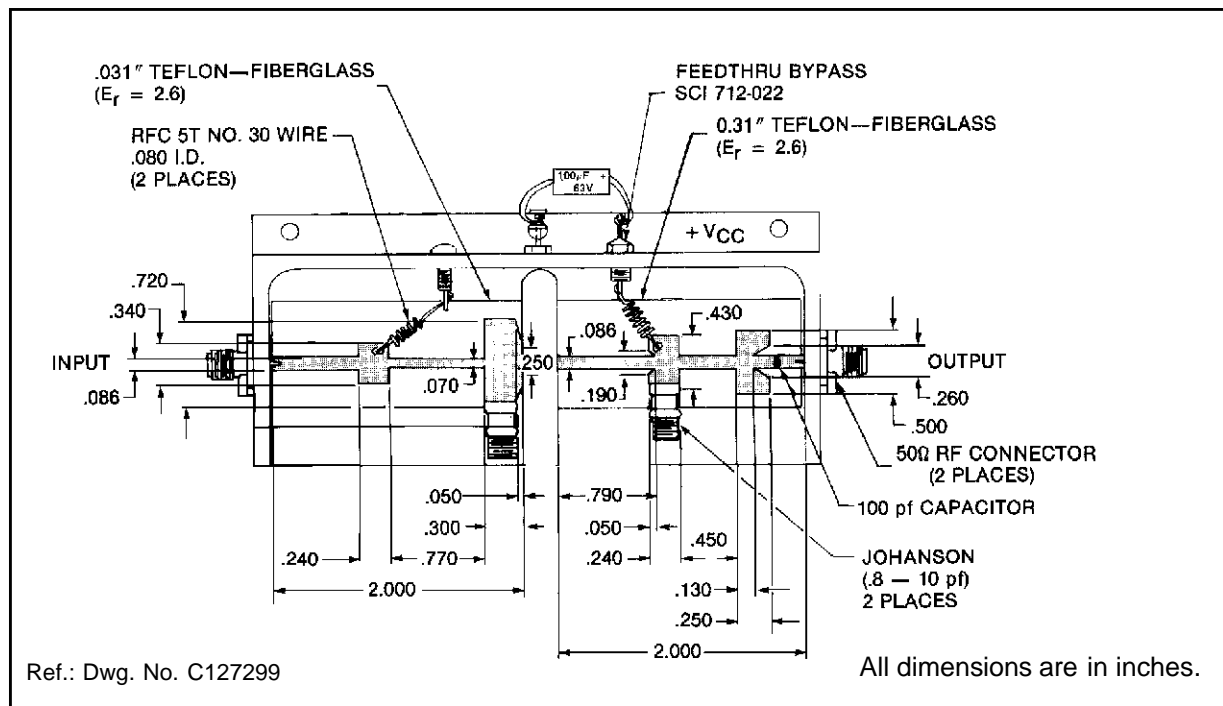
**ELECTRICAL SPECIFICATIONS** ( $T_{\text{case}} = 25^{\circ}\text{C}$ )**STATIC**

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
$BV_{\text{CBO}}$	$I_{\text{C}} = 1 \text{ mA}$ $I_{\text{E}} = 0 \text{ mA}$	45	—	—	V
$BV_{\text{CER}}$	$I_{\text{C}} = 5 \text{ mA}$ $R_{\text{BE}} = 10 \Omega$	45	—	—	V
$BV_{\text{EBO}}$	$I_{\text{E}} = 1 \text{ mA}$ $I_{\text{C}} = 0 \text{ mA}$	3.5	—	—	V
$I_{\text{CES}}$	$V_{\text{CE}} = 28 \text{ V}$	—	—	1.0	mA
$h_{\text{FE}}$	$V_{\text{CE}} = 5 \text{ V}$ $I_{\text{C}} = 200 \text{ mA}$	30	—	300	—

**DYNAMIC**

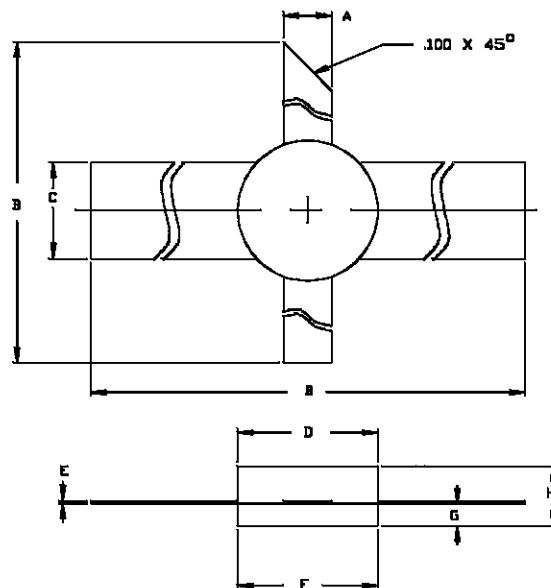
Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
$P_{\text{OUT}}$	$f = 1025 - 1150 \text{ MHz}$ $P_{\text{IN}} = 500 \text{ mW}$ $V_{\text{CC}} = 28 \text{ V}$	4.0	—	—	W
$\eta_{\text{c}}$	$f = 1025 - 1150 \text{ MHz}$ $P_{\text{IN}} = 500 \text{ mW}$ $V_{\text{CC}} = 28 \text{ V}$	35	—	—	%
$G_{\text{P}}$	$f = 1025 - 1150 \text{ MHz}$ $P_{\text{IN}} = 500 \text{ mW}$ $V_{\text{CC}} = 28 \text{ V}$	9.0	—	—	dB

Note: Pulse Width =  $10 \mu\text{Sec}$   
Duty Cycle = 1%

**TEST CIRCUIT**

## PACKAGE MECHANICAL DATA

Ref.: Dwg. No. 12-0217 rev. A



SGS-THOMSON MICROELECTRONICS		
	MINIMUM Inches/mm	MAXIMUM Inches/mm
A	.095/2,41	.105/2,67
B	1.050/26,67	
C	.195/4,95	.205/5,21
D	.275/6,99	.285/7,24
E	.004/0,10	.007/0,18
F		.280/7,11
G	.050/1,27	.070/1,78
H		.145/3,68

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